

- Ultra-Fast Operation . . . 10 ns (typ)
- Low Positive Supply Current  
12.7 mA (Typ)
- Operates From a Single 5-V Supply or From  
a Split  $\pm 5$ -V Supply
- Complementary Outputs
- Input Common-Mode Voltage Includes  
Negative Rail
- Low Offset Voltage
- No Minimum Slew Rate Requirement
- Output Latch Capability
- Functional Replacement to the LT1116

## description

The TL3116 is an ultra-fast comparator designed to interface directly to TTL logic while operating from either a single 5-V power supply or dual  $\pm 5$ -V supplies. The input common-mode voltage extends to the negative rail for ground sensing applications. It features extremely tight offset voltage and high gain for precision applications. It has complementary outputs that can be latched using the LATCH ENABLE terminal. Figure 1 shows the positive supply current of the comparator. The TL3116 only requires 12.7 mA (typical) to achieve a propagation delay of 10 ns.

The TL3116 is a pin-for-pin functional replacement for the LT1116 comparator, offering high-speed operation but consuming much less power.

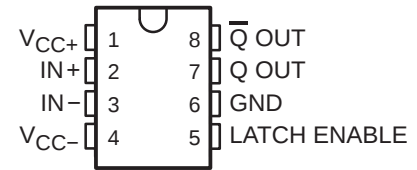
### AVAILABLE OPTIONS

| $T_A$         | PACKAGED DEVICES                  |               | CHIP FORM <sup>‡</sup><br>(Y) |
|---------------|-----------------------------------|---------------|-------------------------------|
|               | SMALL OUTLINE <sup>†</sup><br>(D) | TSSOP<br>(PW) |                               |
| 0°C to 70°C   | TL3116CD                          | TL3116CPWLE   | TL3116Y                       |
| -40°C to 85°C | TL3116ID                          | TL3116IPWLE   | —                             |

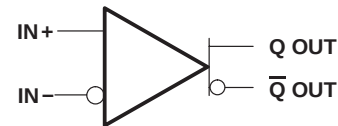
<sup>†</sup> The PW packages are available left-ended taped and reeled only.

<sup>‡</sup> Chip forms are tested at  $T_A = 25^\circ\text{C}$  only.

### D AND PW PACKAGE (TOP VIEW)



### symbol (each comparator)



### POSITIVE SUPPLY CURRENT vs FREE-AIR TEMPERATURE

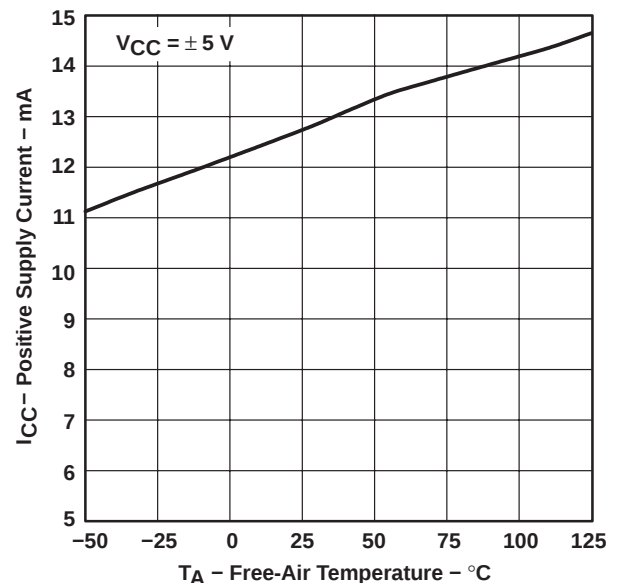


Figure 1



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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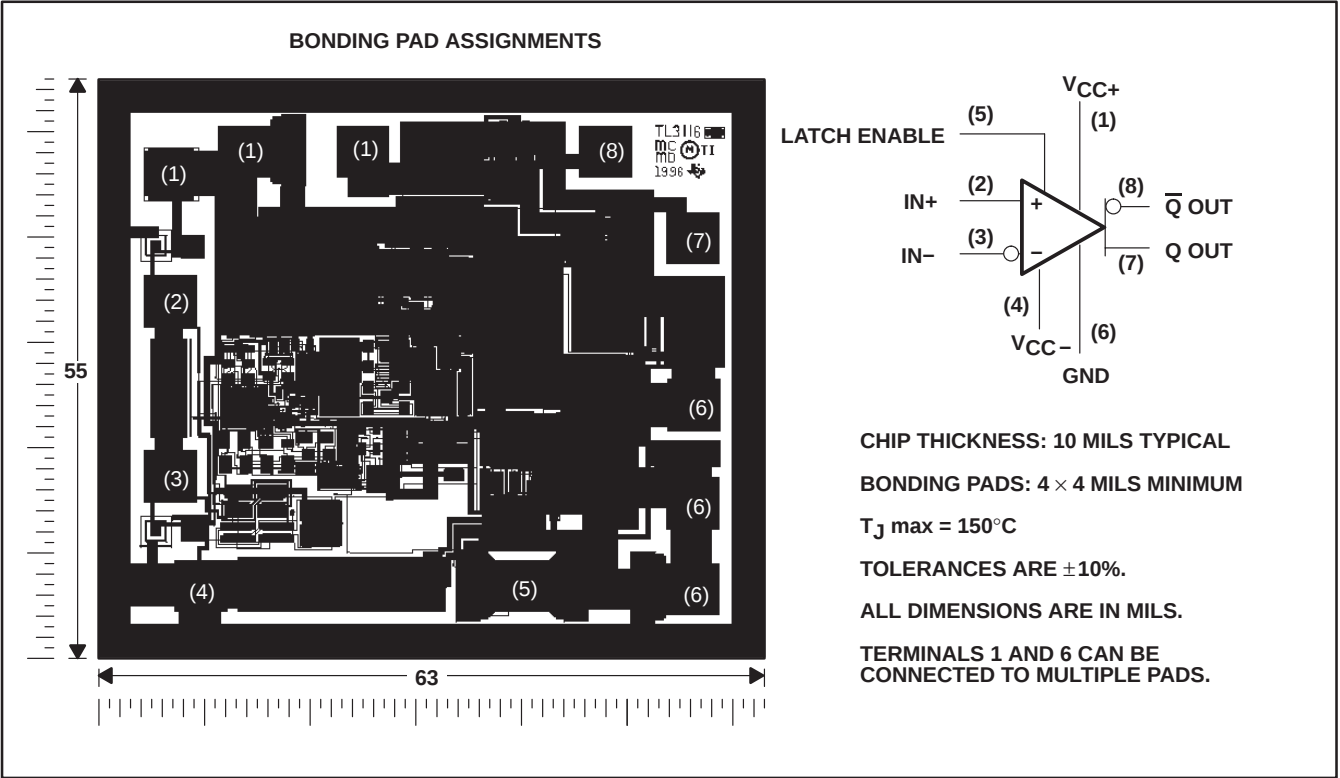
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TL3116, TL3116Y  
ULTRA-FAST LOW-POWER  
PRECISION COMPARATORS

SLCS132C – MARCH 1997 – REVISED MAY 1997

TL3116Y chip information

This chip, when properly assembled, displays characteristics similar to the TL3116C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. Chips may be mounted with conductive epoxy or a gold-silicon preform.



| COMPONENT COUNT |    |
|-----------------|----|
| Bipolars        | 53 |
| MOSFETs         | 49 |
| Resistors       | 46 |
| Capacitors      | 14 |

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

|                                                              |                              |
|--------------------------------------------------------------|------------------------------|
| Supply voltage, $V_{DD}$ (see Note 1)                        | – 7 V to 7 V                 |
| Differential input voltage, $V_{ID}$ (see Note 2)            | 7 V                          |
| Input voltage range, $V_I$                                   | 7 V                          |
| Input voltage, $V_I$ (LATCH ENABLE)                          | 7 V                          |
| Output current, $I_O$                                        | $\pm 20$ mA                  |
| Continuous total power dissipation                           | See Dissipation Rating Table |
| Operating free-air temperature range, $T_A$                  | –40°C to 85°C                |
| Storage temperature range, $T_{Stg}$                         | – 65°C to 150°C              |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C                        |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to network ground.  
 2. Differential voltages are at  $IN+$  with respect to  $IN-$ .

**DISSIPATION RATING TABLE**

| PACKAGE | $T_A \leq 25^\circ\text{C}$<br>POWER RATING | DERATING FACTOR<br>ABOVE $T_A = 25^\circ\text{C}$ | $T_A = 70^\circ\text{C}$<br>POWER RATING |
|---------|---------------------------------------------|---------------------------------------------------|------------------------------------------|
| D       | 725 mW                                      | 5.8 mW/°C                                         | 464 mW                                   |
| PW      | 525 mW                                      | 4.2 mW/°C                                         | 336 mW                                   |

# TL3116, TL3116Y

## ULTRA-FAST LOW-POWER

## PRECISION COMPARATORS

SLCS132C – MARCH 1997 – REVISED MAY 1997

electrical characteristics at specified operating free-air temperature,  $V_{DD} = \pm 5\text{ V}$ ,  $V_{LE} = 0$  (unless otherwise noted)

| PARAMETER      |                                                 | TEST CONDITIONS†                                                                          | TL3116C |      |      | TL3116I |      |      | UNIT                         |
|----------------|-------------------------------------------------|-------------------------------------------------------------------------------------------|---------|------|------|---------|------|------|------------------------------|
|                |                                                 |                                                                                           | MIN     | TYP‡ | MAX  | MIN     | TYP‡ | MAX  |                              |
| $V_{IO}$       | Input offset voltage                            | $T_A = 25^\circ\text{C}$                                                                  |         | 0.5  | 3    |         | 0.5  | 3    | mV                           |
|                |                                                 | $T_A = \text{full range}$                                                                 |         |      | 3.5  |         |      | 3.5  |                              |
| $\alpha_{VIO}$ | Temperature coefficient of input offset voltage |                                                                                           |         | -2.5 |      |         | -2.8 |      | $\mu\text{V}/^\circ\text{C}$ |
| $I_{IO}$       | Input offset current                            | $T_A = 25^\circ\text{C}$                                                                  |         | 0.1  | 0.2  |         | 0.1  | 0.2  | $\mu\text{A}$                |
|                |                                                 | $T_A = \text{full range}$                                                                 |         |      | 0.3  |         |      | 0.35 |                              |
| $I_{IB}$       | Input bias current                              | $T_A = 25^\circ\text{C}$                                                                  |         | 0.7  | 1.1  |         | 0.7  | 1.1  | $\mu\text{A}$                |
|                |                                                 | $T_A = \text{full range}$                                                                 |         |      | 1.2  |         |      | 1.5  |                              |
| $V_{ICR}$      | Common-mode input voltage range                 | $V_{DD} = \pm 5\text{ V}$                                                                 | -5      |      | 2.5  | -5      |      | 2.5  | V                            |
|                |                                                 | $V_{DD} = 5\text{ V}$                                                                     | 0       |      | 2.5  | 0       |      | 2.5  |                              |
| CMRR           | Common-mode rejection ratio                     | $-5 \leq V_{IC} \leq 2.5\text{ V}$                                                        | 75      | 100  |      | 75      | 100  |      | dB                           |
| $k_{SVR}$      | Supply-voltage rejection ratio                  | Positive supply: $4.6\text{ V} \leq +V_{DD} \leq 5.4\text{ V}$ , $T_A = 25^\circ\text{C}$ | 60      | 80   |      | 60      | 80   |      | dB                           |
|                |                                                 | Negative supply: $-7\text{ V} \leq -V_{DD} \leq -2\text{ V}$ , $T_A = 25^\circ\text{C}$   | 80      | 100  |      | 80      | 100  |      |                              |
| $V_{OL}$       | Low-level output voltage                        | $I_{(\text{sink})} = 4\text{ mA}$ , $V+ \leq 4.6\text{ V}$ , $T_A = 25^\circ\text{C}$     |         | 400  | 600  |         | 400  | 600  | mV                           |
|                |                                                 | $I_{(\text{sink})} = 10\text{ mA}$ , $V+ \leq 4.6\text{ V}$ , $T_A = 25^\circ\text{C}$    |         | 750  |      |         | 750  |      |                              |
| $V_{OH}$       | High-level output voltage                       | $V+ \leq 4.6\text{ V}$ , $T_A = 25^\circ\text{C}$ , $I_O = 1\text{ mA}$                   | 3.6     | 3.9  |      | 3.6     | 3.9  |      | V                            |
|                |                                                 | $V+ \leq 4.6\text{ V}$ , $T_A = 25^\circ\text{C}$ , $I_O = 10\text{ mA}$                  | 3.4     | 3.8  |      | 3.4     | 3.8  |      |                              |
| $I_{CC}$       | Positive supply current                         | $T_A = \text{full range}$                                                                 |         | 12.7 | 14.7 |         | 12.7 | 15   | mA                           |
|                | Negative supply current                         |                                                                                           |         | -2.6 |      |         | -3   |      |                              |
| $V_{IL}$       | Low-level input voltage (LATCH ENABLE)          |                                                                                           |         |      | 0.8  |         |      | 0.8  | V                            |
| $V_{IH}$       | High-level input voltage (LATCH ENABLE)         |                                                                                           | 2       |      |      | 2       |      |      | V                            |
| $I_{IL}$       | Low-level input current (LATCH ENABLE)          | $V_{LE} = 0$                                                                              |         | 0    | 1    |         | 0    | 1    | $\mu\text{A}$                |
|                |                                                 | $V_{LE} = 2\text{ V}$                                                                     |         | 24   | 39   |         | 24   | 45   | $\mu\text{A}$                |

† Full range for the TL3116C is  $T_A = 0^\circ\text{C}$  to  $70^\circ\text{C}$ . Full range for the TL3116I is  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$ .

‡ All typical values are measures with  $T_A = 25^\circ\text{C}$ .



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switching characteristics,  $V_{DD} = \pm 5\text{ V}$ ,  $V_{LE} = 0$

| PARAMETER                                      | TEST CONDITIONS†                                                                    |                           | TL3116C |     |      | TL3116I |     |      | UNIT |
|------------------------------------------------|-------------------------------------------------------------------------------------|---------------------------|---------|-----|------|---------|-----|------|------|
|                                                |                                                                                     |                           | MIN     | TYP | MAX  | MIN     | TYP | MAX  |      |
| $t_{pd1}$ Propagation delay time‡              | $\Delta V_I = 100\text{ mV}$ ,<br>$V_{OD} = 5\text{ mV}$                            | $T_A = 25^\circ\text{C}$  |         | 9.9 | 12   |         | 9.9 | 12   | ns   |
|                                                |                                                                                     | $T_A = \text{full range}$ |         | 9.9 | 14   |         | 9.9 | 15   |      |
|                                                | $\Delta V_I = 100\text{ mV}$ ,<br>$V_{OD} = 20\text{ mV}$                           | $T_A = 25^\circ\text{C}$  |         | 8.2 | 10.3 |         | 8.2 | 10.3 |      |
|                                                |                                                                                     | $T_A = \text{full range}$ |         | 8.2 | 12.7 |         | 8.2 | 13.7 |      |
| $t_{sk(p)}$ Pulse skew ( $t_{pd+} - t_{pd-}$ ) | $\Delta V_I = 100\text{ mV}$ , $V_{OD} = 5\text{ mV}$ ,<br>$T_A = 25^\circ\text{C}$ |                           |         | 0.5 |      |         | 0.5 |      | ns   |
| $t_{su}$ Setup time, LATCH ENABLE              |                                                                                     |                           |         | 3.4 |      |         | 3.4 |      | ns   |

† Full range for the TL3116C is  $0^\circ\text{C}$  to  $70^\circ\text{C}$ . Full range for the TL3116I is  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

‡  $t_{pd1}$  cannot be measured in automatic handling equipment with low values of overdrive. The TL3116 is 100% tested with a 1-V step and 500-mV overdrive at  $T_A = 25^\circ\text{C}$  only. Correlation tests have shown that  $t_{pd1}$  limits given can be ensured with this test, if additional dc tests are performed to ensure that all internal bias conditions are correct. For low overdrive conditions,  $V_{OS}$  is added to the overdrive.

## TYPICAL CHARACTERISTICS

Table of Graphs

|                                                 |                          | FIGURE |
|-------------------------------------------------|--------------------------|--------|
| $I_{CC}$ Positive supply current                | vs Input voltage         | 2      |
|                                                 | vs Frequency             | 3      |
|                                                 | vs Free-air temperature  | 4      |
| $I_{CC}$ Negative supply current                | vs Free-air temperature  | 5      |
| $t_{pd}$ Propagation delay time                 | vs Overdrive voltage     | 6      |
|                                                 | vs Supply voltage        | 7      |
|                                                 | vs Input impedance       | 8      |
|                                                 | vs Load capacitance      | 9      |
|                                                 | vs Free-air temperature  | 10     |
| $V_{IC}$ Common-mode input voltage              | vs Free-air temperature  | 11     |
| $V_{IT}$ Input threshold voltage (LATCH ENABLE) | vs Free-air temperature  | 12     |
| $V_O$ Output voltage                            | vs Output source current | 13     |
|                                                 | vs Output sink current   | 14     |
| $I_I$ Input current (LATCH ENABLE)              | vs Input voltage         | 15     |

## TYPICAL CHARACTERISTICS

POSITIVE SUPPLY CURRENT  
vs  
INPUT VOLTAGE

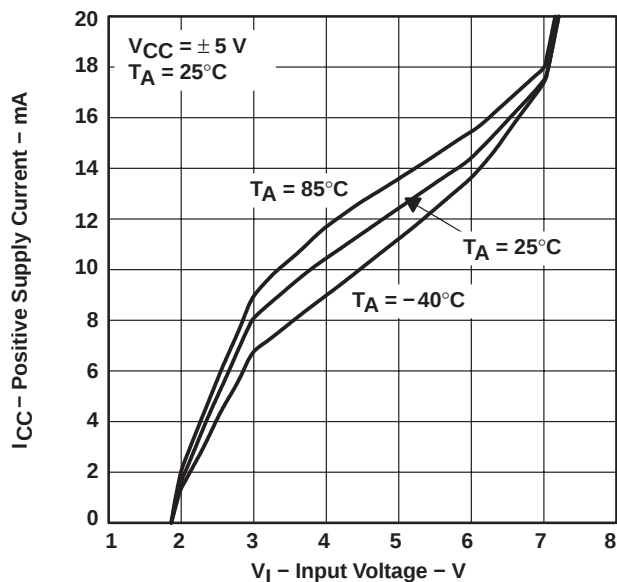


Figure 2

POSITIVE SUPPLY CURRENT  
vs  
FREQUENCY

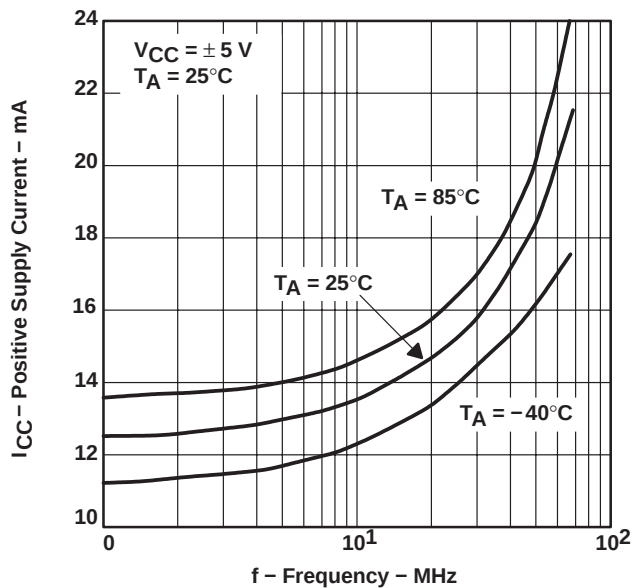


Figure 3

POSITIVE SUPPLY CURRENT  
vs  
FREE-AIR TEMPERATURE

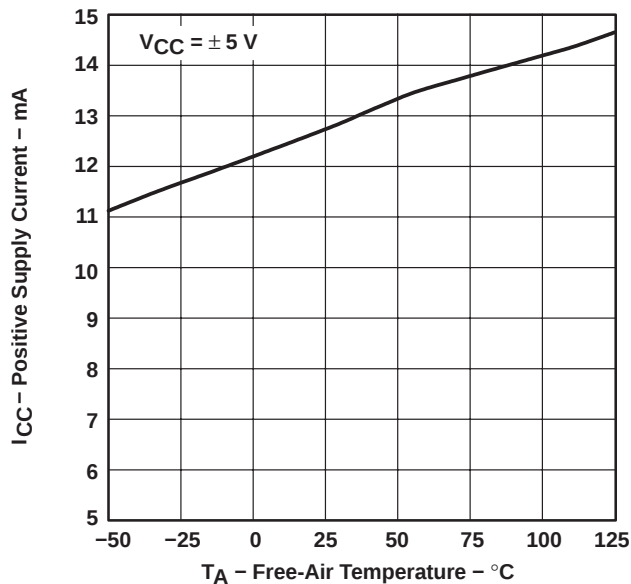


Figure 4

NEGATIVE SUPPLY CURRENT  
vs  
FREE-AIR TEMPERATURE

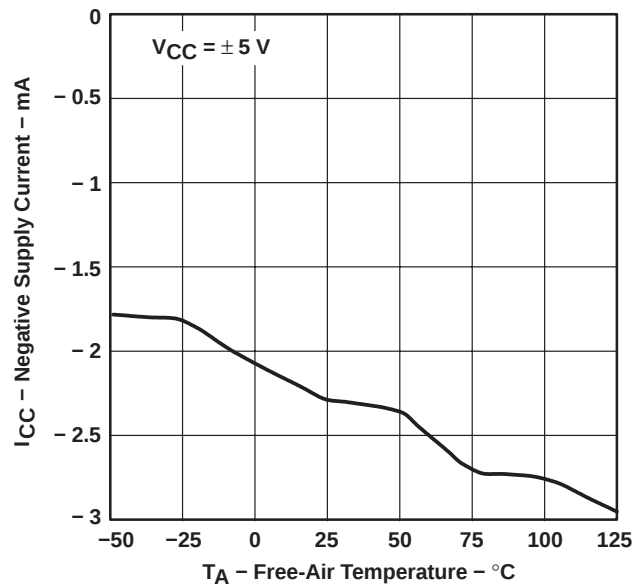


Figure 5

## TYPICAL CHARACTERISTICS

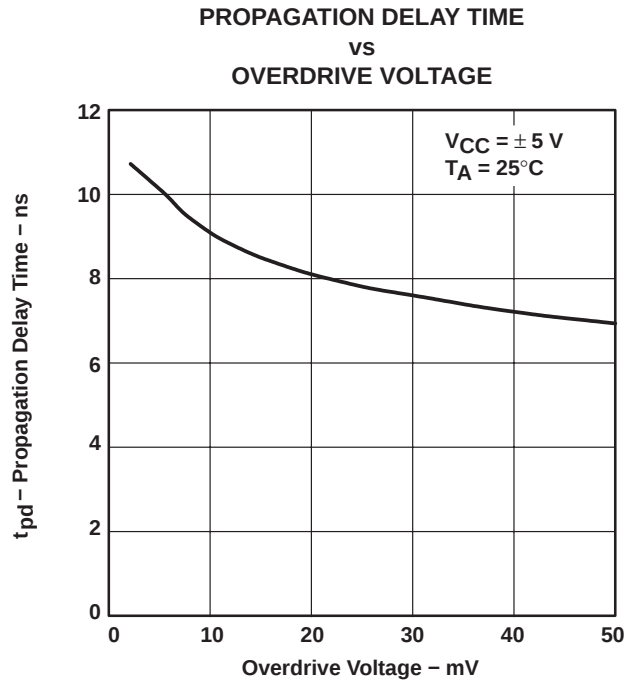


Figure 6

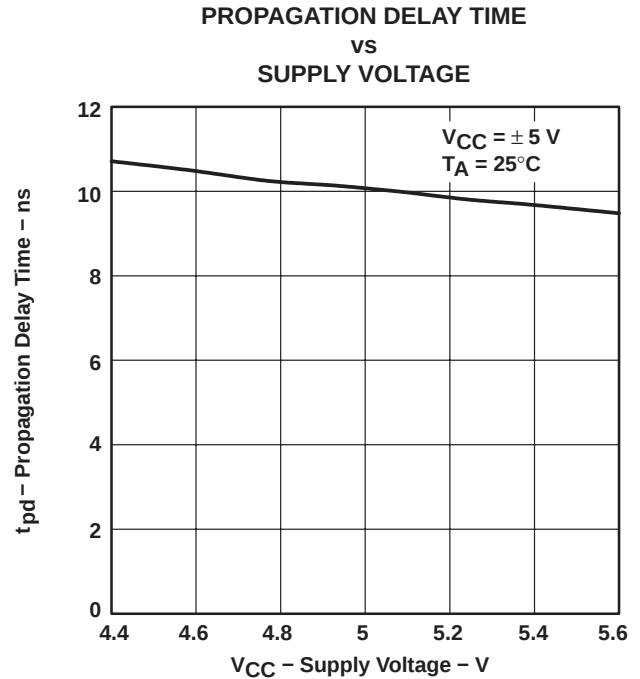


Figure 7

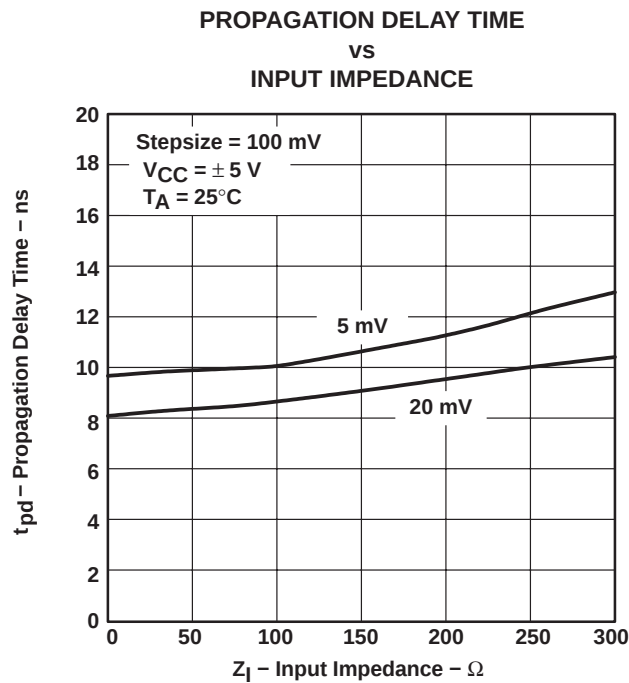


Figure 8

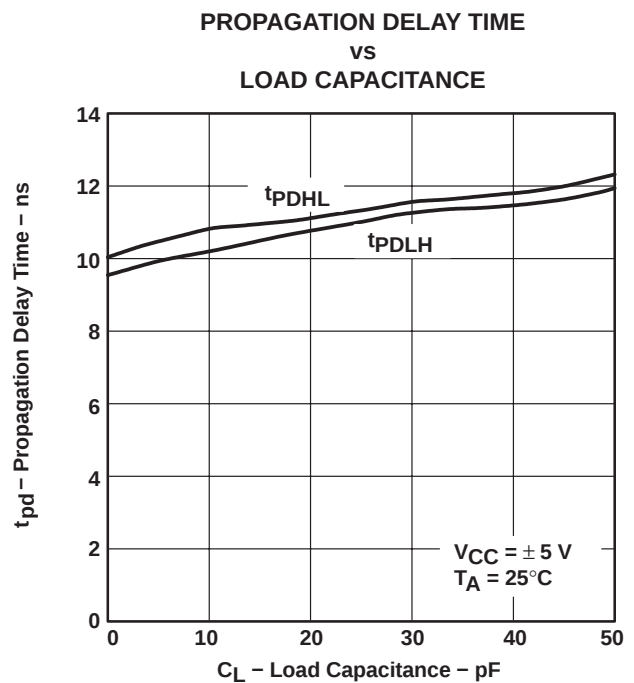


Figure 9

## TYPICAL CHARACTERISTICS

PROPAGATION DELAY TIME  
 VS  
 FREE-AIR TEMPERATURE

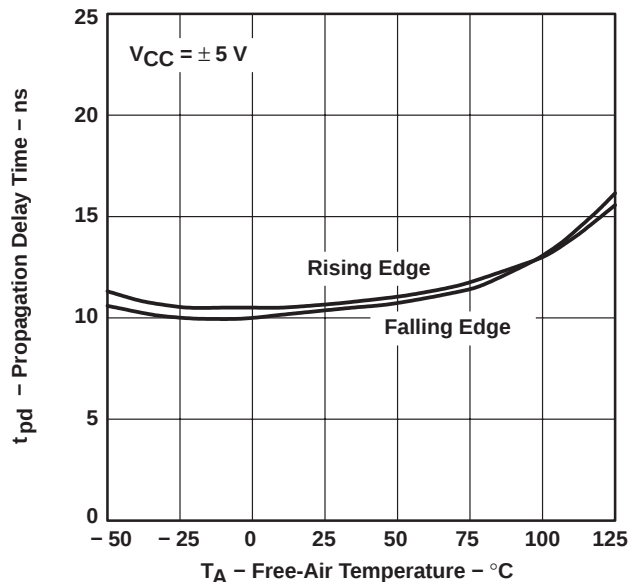


Figure 10

COMMON-MODE INPUT VOLTAGE  
 VS  
 FREE-AIR TEMPERATURE

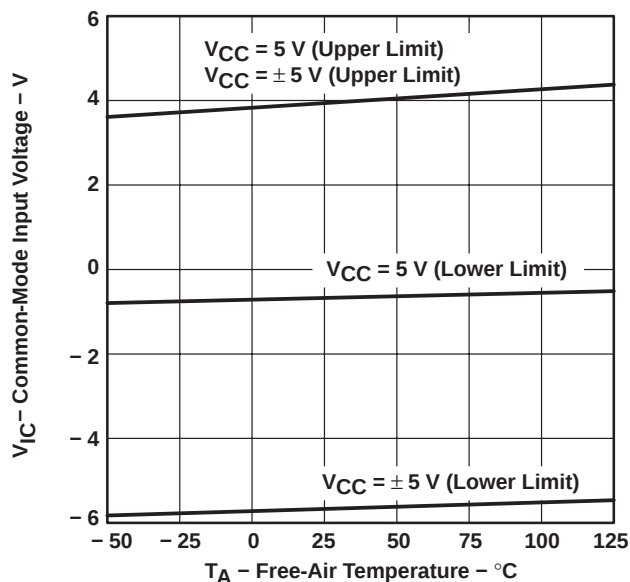


Figure 11

INPUT THRESHOLD VOLTAGE (LATCH ENABLE)  
 VS  
 FREE-AIR TEMPERATURE

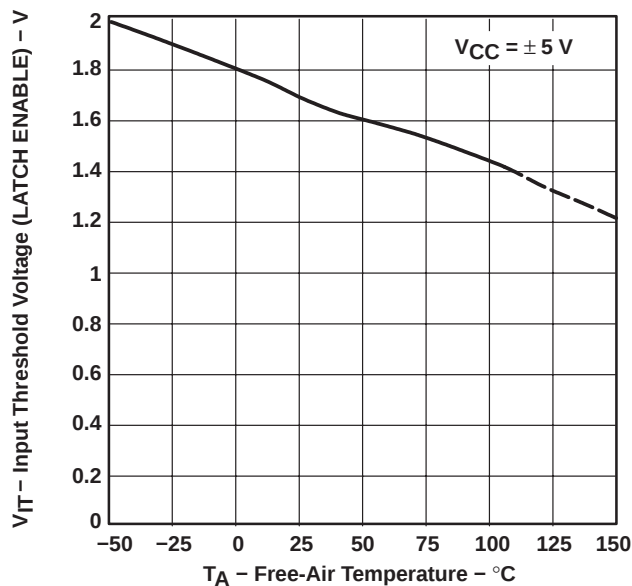


Figure 12

OUTPUT VOLTAGE  
 VS  
 OUTPUT SOURCE CURRENT

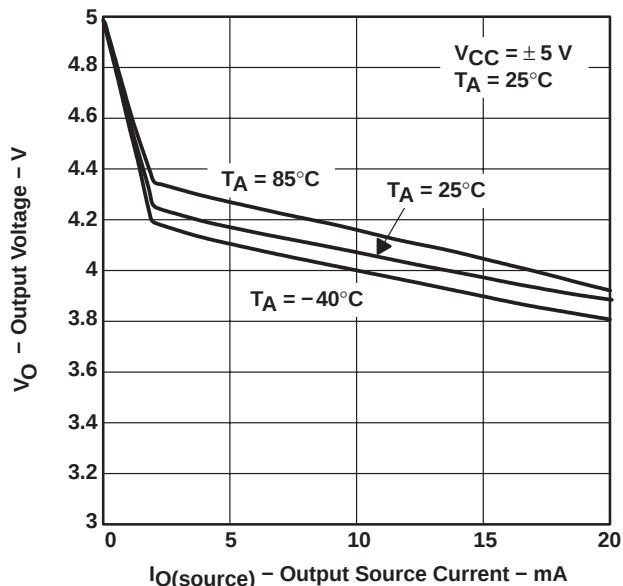


Figure 13

TYPICAL CHARACTERISTICS

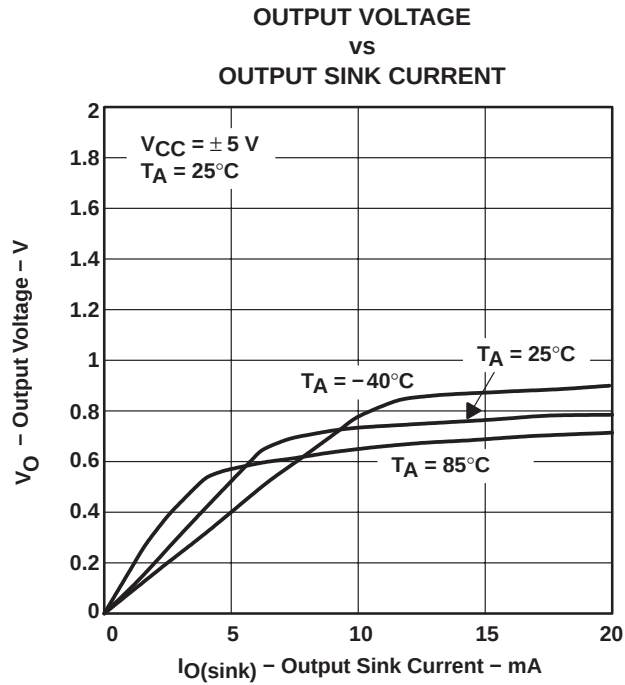


Figure 14

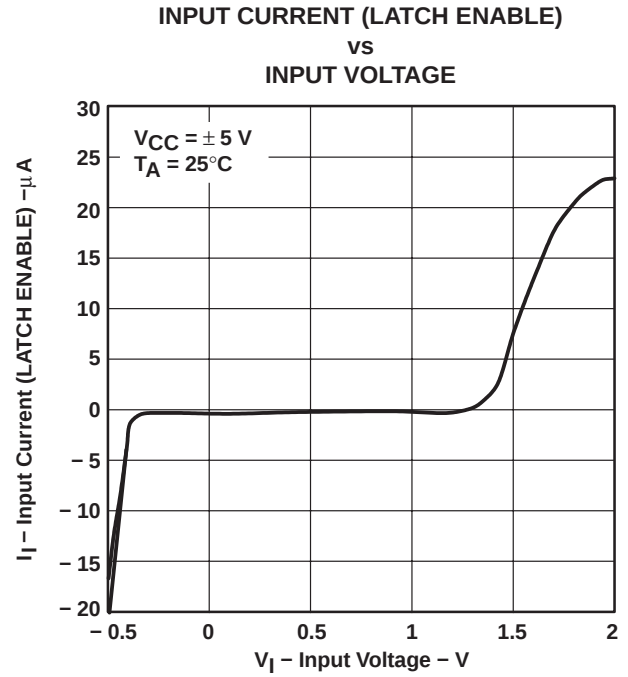


Figure 15

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TL3116CD</a>     | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 3116C               |
| <a href="#">TL3116CDR</a>    | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 3116C               |
| <a href="#">TL3116CPWR</a>   | Obsolete      | Production           | TSSOP (PW)   8 | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | T3116               |
| <a href="#">TL3116ID</a>     | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | 3116I               |
| <a href="#">TL3116IDR</a>    | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 3116I               |
| <a href="#">TL3116IDR.A</a>  | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 3116I               |
| <a href="#">TL3116IPWR</a>   | Active        | Production           | TSSOP (PW)   8 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | Z3116               |
| <a href="#">TL3116IPWR.A</a> | Active        | Production           | TSSOP (PW)   8 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | Z3116               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

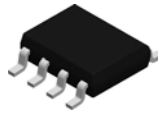
| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TL3116IDR  | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL3116IPWR | TSSOP        | PW              | 8    | 2000 | 330.0              | 12.4               | 7.0     | 3.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL3116IDR  | SOIC         | D               | 8    | 2500 | 350.0       | 350.0      | 43.0        |
| TL3116IPWR | TSSOP        | PW              | 8    | 2000 | 356.0       | 356.0      | 35.0        |

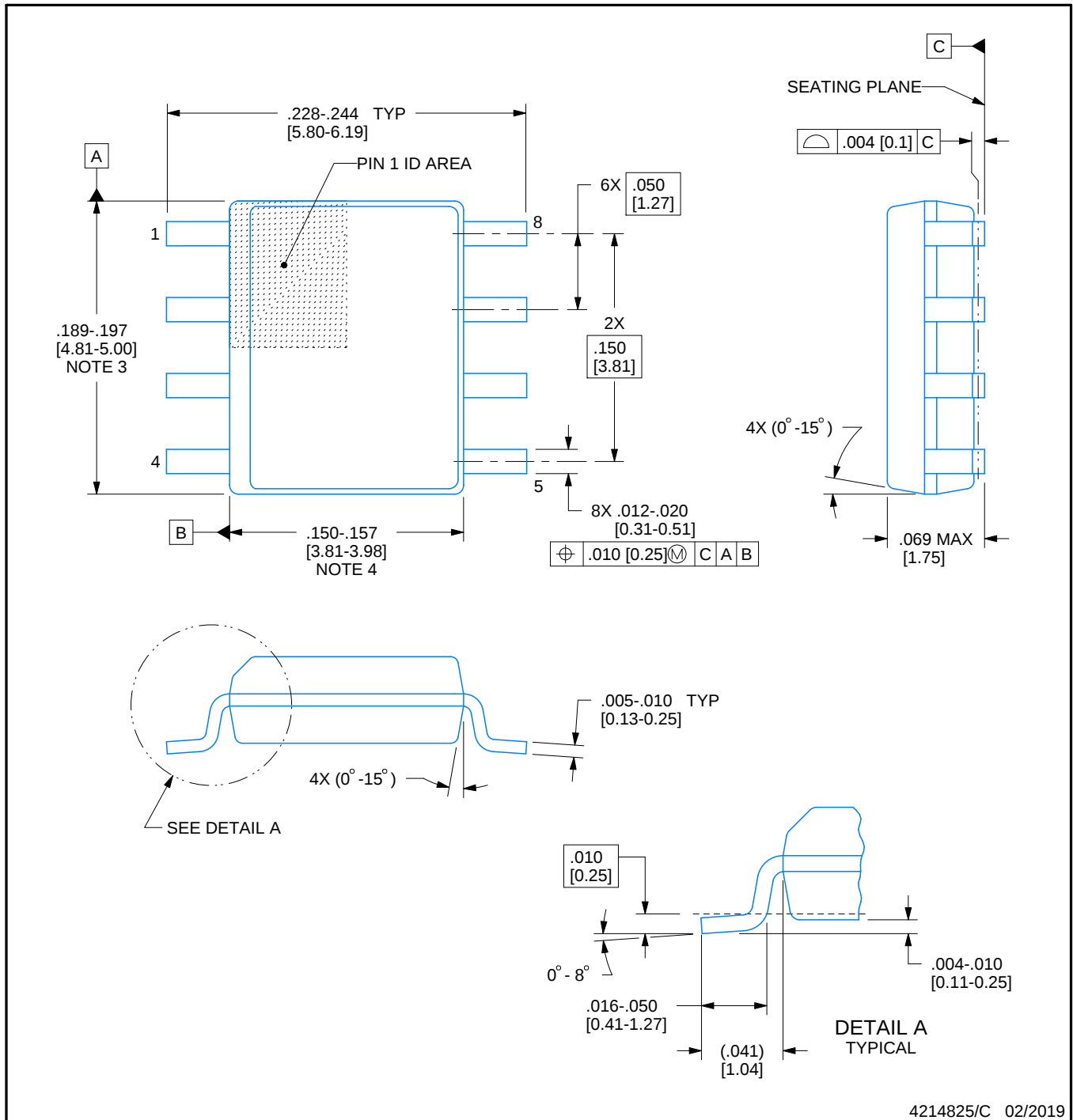


**D0008A**

# PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



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## NOTES:

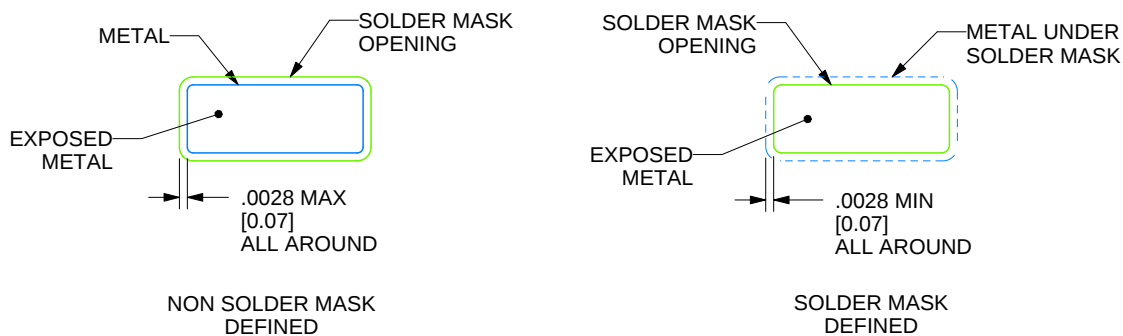
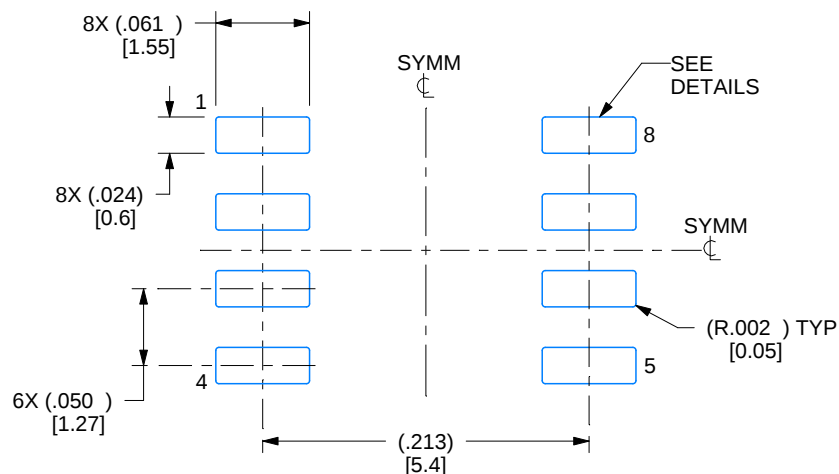
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

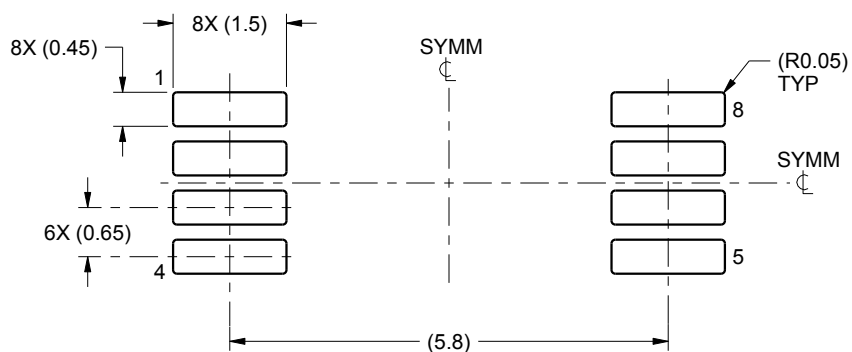
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



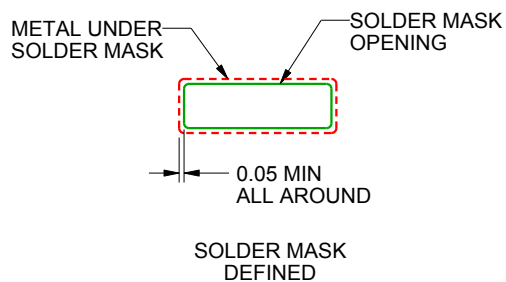
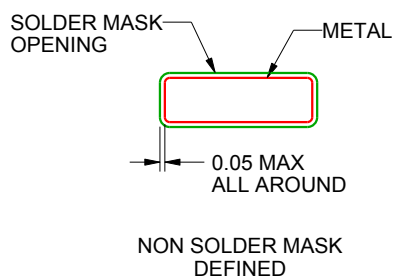
**PW0008A**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:10X



SOLDER MASK DETAILS  
NOT TO SCALE

4221848/A 02/2015

NOTES: (continued)

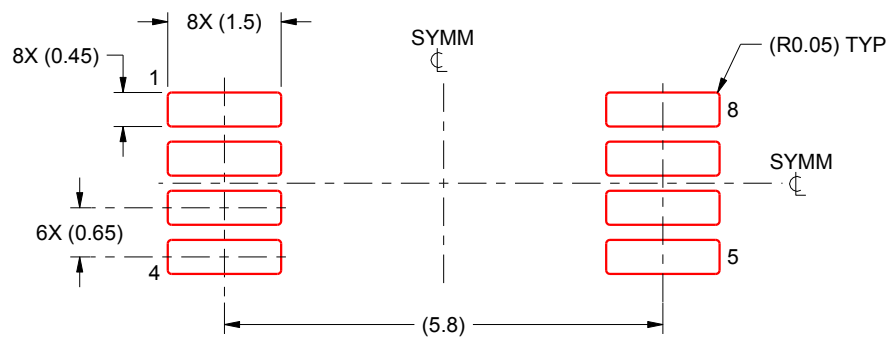
6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

**PW0008A**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:10X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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